

January 2000 Revised October 2001

# 74LVT16952 • 74LVTH16952 Low Voltage 16-Bit Registered Transceiver with 3-STATE Outputs

#### **General Description**

The LVT16952 and LVTH16952 are 16-bit registered transceivers. Two 8-bit back to back registers store data flowing in both directions between two bidirectional buses. Separate clock, clock enable, and output enable signals are provided for each register.

The LVTH16952 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

The registered transceiver is designed for low-voltage (3.3V) V<sub>CC</sub> applications, but with the capability to provide a TTL interface to a 5V environment.

The LVT16952 and LVTH16952 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT while maintaining low power dissipation.

#### **Features**

- $\blacksquare$  Input and output interface capability to systems at 5V  $V_{CC}$
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused inputs (74LVTH16952)
- Live insertion/extraction permitted
- Power Up/Down high impedance provides glitch-free bus loading
- Outputs source/sink -32 mA/+64 mA
- Functionally compatible with the 74 series 16952
- Latch-up conforms to JEDEC JED78
- ESD performance:

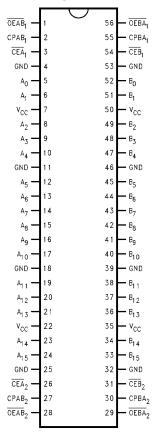
Human-body model > 2000V Machine model > 200V Charged-device model > 1000V

#### **Ordering Code:**

Order Number	Package Number	Package Description
74LVT16952MEA (Preliminary)	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
74LVT16952MTD (Preliminary)	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide
74LVTH16952MEA	MS56A	56-Lead Shrink Small Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
74LVTH16952MTD	MTD56	56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

## **Connection Diagram**



## **Pin Descriptions**

Pin Names	Description
A <sub>0</sub> -A <sub>16</sub>	Data Register A Inputs B-Register 3-STATE Outputs
B <sub>0</sub> -B <sub>16</sub>	Data Register B Inputs A-Register 3-STATE Outputs
CPAB <sub>n</sub> , CPBA <sub>n</sub>	Clock Pulse Inputs
$\overline{CEA}_n$ , $\overline{CEB}_n$	Clock Enable
$\overline{OEAB}_n, \overline{OEBA}_n$	Output Enable Inputs

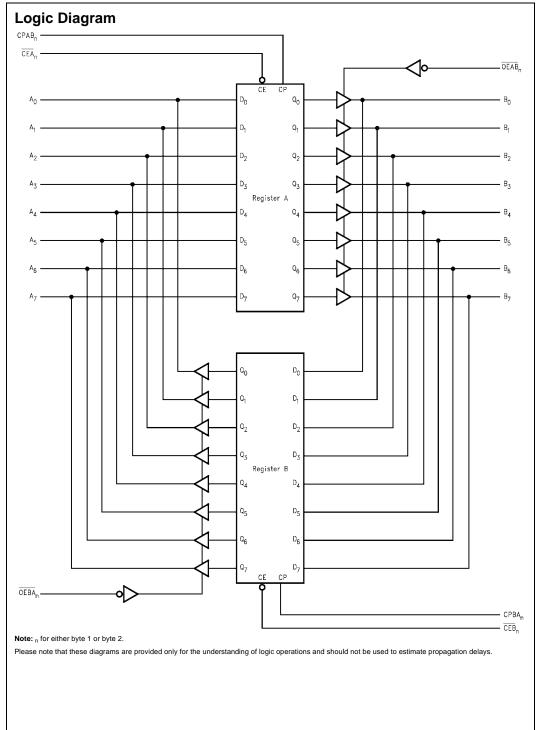
#### **Truth Table**

(Note 1)

Inputs				Internal Register	Output
A <sub>n</sub>	CPAB <sub>n</sub>	$\overline{\text{CEA}}_n$	$\overline{\text{OEAB}}_n$	Value	B <sub>n</sub>
Х	Х	Н	L	NC	B <sub>0</sub>
Х	Х	Н	Н	NC	Z
L	~	L	L	L	L
L	_	L	Н	L	Z
Н	~	L	L	Н	Н
Н	~	L	Н	Н	Z
Х	L	Х	L	NC	B <sub>0</sub>
Х	Н	Х	L	NC	B <sub>0</sub>
Х	L	Х	Н	NC	Z
Х	Н	Х	Н	NC	Z

Note 1: A to B data flow shown; B to A flow control is the same, but used  $\overline{\text{OEBA}}_n$ , CPBA<sub>n</sub> and  $\overline{\text{CEB}}_n$ .

H = HIGH Voltage Level L = LOW Voltage Level



## Absolute Maximum Ratings(Note 2)

Symbol	Parameter	Value	Conditions	Units
V <sub>CC</sub>	Supply Voltage	-0.5 to +4.6		V
VI	DC Input Voltage	-0.5 to +7.0		V
Vo	DC Output Voltage	-0.5 to +7.0	Output in 3-STATE	V
		-0.5 to +7.0	Output in HIGH or LOW State (Note 3)	V
I <sub>IK</sub>	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA
I <sub>OK</sub>	DC Output Diode Current	-50	V <sub>O</sub> < GND	mA
Io	DC Output Current	64	V <sub>O</sub> > V <sub>CC</sub> Output at HIGH State	mA
		128	V <sub>O</sub> > V <sub>CC</sub> Output at LOW State	ША
I <sub>CC</sub>	DC Supply Current per Supply Pin	±64		mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	±128		mA
T <sub>STG</sub>	Storage Temperature	-65 to +150		°C

# **Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Units
V <sub>CC</sub>	Supply Voltage	2.7	3.6	V
VI	Input Voltage	0	5.5	V
I <sub>OH</sub>	HIGH-Level Output Current		-32	mA
I <sub>OL</sub>	LOW-Level Output Current		64	IIIA
T <sub>A</sub>	Free-Air Operating Temperature	-40	+85	°C
Δt/ΔV	Input Edge Rate, V <sub>IN</sub> = 0.8V–2.0V, V <sub>CC</sub> = 3.0V	0	10	ns/V

Note 2: Absolute Maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum rated conditions is not implied.

Note 3: I<sub>O</sub> Absolute Maximum Rating must be observed.

Symbol	B		V <sub>CC</sub>	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Unita	Conditions
Зуппоот	Parameter		(V)	Min	Max	Units	Conditions
V <sub>IK</sub>	Input Clamp Diode Voltage		2.7		-1.2	V	$I_{I} = -18 \text{ mA}$
V <sub>IH</sub>	Input HIGH Voltage		2.7-3.6	2.0		V	V <sub>O</sub> ≤ 0.1V or
V <sub>IL</sub>	Input LOW Voltage		2.7-3.6		0.8	V	$V_O \ge V_{CC} - 0.1V$
V <sub>OH</sub>	Output HIGH Voltage		2.7-3.6	V <sub>CC</sub> - 0.2		V	$I_{OH} = -100 \mu A$
			2.7	2.4		V	$I_{OH} = -8 \text{ mA}$
			3.0	2.0		V	$I_{OH} = -32 \text{ mA}$
V <sub>OL</sub>	Output LOW Voltage		2.7		0.2	V	$I_{OL} = 100 \mu A$
			2.7		0.5	V	I <sub>OL</sub> = 24 mA
			3.0		0.4	V	I <sub>OL</sub> = 16 mA
			3.0		0.5	V	I <sub>OL</sub> = 32 mA
			3.0		0.55	V	I <sub>OL</sub> = 64 mA
I <sub>I(HOLD)</sub>	Bushold Input Minimum Drive	Э	3.0	75		μΑ	$V_{I} = 0.8V$
(Note 4)			3.0	-75		μΑ	$V_{I} = 2.0V$
I <sub>I(OD)</sub>	Bushold Input Over-Drive	Bushold Input Over-Drive		500		μΑ	(Note 5)
(Note 4)	Current to Change State		3.0	-500		μΑ	(Note 6)
l <sub>l</sub>	Input Current		3.6		10	μΑ	$V_{I} = 5.5V$
		Control Pins	3.6		±1	μΑ	$V_I = 0V$ or $V_{CC}$
		Data Pins	3.6		-5	μΑ	$V_I = 0V$
		Data Pins	3.0		1	μΑ	$V_I = V_{CC}$
l <sub>OFF</sub>	Power Off Leakage Current		0		±100	μΑ	$0V \le V_I \text{ or } V_O \le 5.5V$
I <sub>PU/PD</sub>	Power Up/Down 3-STATE		0.45\/		1400		$V_0 = 0.5V \text{ to } 3.0V$
	Output Current		0-1.5V		±100	μΑ	$V_I = GND \text{ or } V_{CC}$
I <sub>OZL</sub>	3-STATE Output Leakage Cu	ırrent	3.6		-5	μΑ	V <sub>O</sub> = 3.0V
I <sub>OZL</sub>	3-STATE Output Leakage Cu	ırrent	3.6		-5	μΑ	V <sub>O</sub> = 0.0V
(Note 4)							
l <sub>ozh</sub>	3-STATE Output Leakage Cu	ırrent	3.6		5	μΑ	V <sub>O</sub> = 0.5V
l <sub>ozh</sub>	3-STATE Output Leakage Cu	ırrent	3.6		5	μΑ	V <sub>O</sub> = 3.6V
(Note 4)							
I <sub>OZH</sub> +	3-STATE Output Leakage Cu	ırrent	3.6		10	μΑ	$V_{CC} < V_O \le 5.5V$
Іссн	Power Supply Current		3.6		0.19	mA	Outputs High
I <sub>CCL</sub>	Power Supply Current		3.6		5	mA	Outputs Low
I <sub>CCZ</sub>	Power Supply Current		3.6		0.19	mA	Outputs Disabled
I <sub>CCZ</sub> +	Power Supply Current		3.6		0.19	mA	$V_{CC} \le V_O \le 5.5V$ ,
							Outputs Disabled
Δl <sub>CC</sub>	Increase in Power Supply Cu	ırrent	3.6		0.2	mA	One Input at V <sub>CC</sub> – 0.6V
	(Note 7)						Other Inputs at V <sub>CC</sub> or GN

Note 4: Applies to bushold version only (74LVTH16952).

Note 5: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 6: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

 $\textbf{Note 7:} \ \text{This is the increase in supply current for each input that is at the specified voltage level rather than $V_{CC}$ or GND.}$ 

## **Dynamic Switching Characteristics** (Note 8)

Symbol	Parameter	v <sub>cc</sub>	T <sub>A</sub> = 25°C			Units	Conditions	
Symbol	raiametei	(V)	Min	Тур	Max	Oilles	$\textbf{C}_{\textbf{L}} = \textbf{50}~\text{pF,}~\textbf{R}_{\textbf{L}} = \textbf{500}\Omega$	
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	3.3		0.8		V	(Note 9)	
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	3.3		-0.8		V	(Note 9)	

Note 8: Characterized in SSOP package. Guaranteed parameter, but not tested.

Note 9: Max number of outputs defined as (n). n-1 data inputs are driven 0V to 3V. Output under test held LOW.

## **AC Electrical Characteristics**

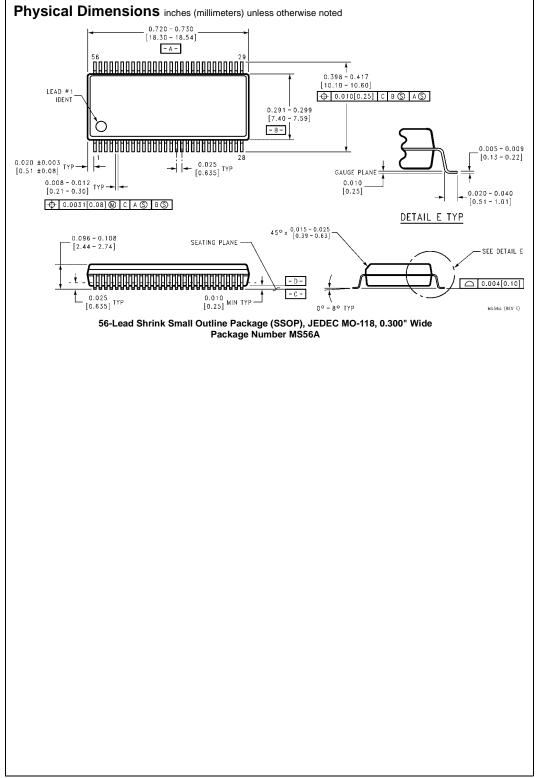
Comple et	Parameter			Units				
Symbol	Parameter			$V_{CC} = 3.3 \pm 0.3 V$		V <sub>CC</sub> = 2.7V		
			Min	Max	Min	Max		
f <sub>MAX</sub>	Maximum Clock Frequ	ency	150		150		MHz	
t <sub>PLH</sub>	Propagation Delay		1.3	4.4	1.3	4.7	ns	
t <sub>PHL</sub>	CPBA or CPAB to A or	CPBA or CPAB to A or B			1.3	5.0	115	
t <sub>PZH</sub>	Output Enable Time	1.0	4.3	1.0	4.9	ns		
t <sub>PZL</sub>	OE to A or B	1.0	4.8	1.0	5.7	115		
t <sub>PHZ</sub>	Output Disable Time	Output Disable Time			2.1	6.2		
t <sub>PLZ</sub>	OE to A or B	2.1	5.1	2.1	5.3	ns		
t <sub>W</sub>	Pulse Width, CPAB or	CPBA HIGH or LOW	3.3		3.3		ns	
t <sub>S</sub>	Setup Time	A or B before CPAB or CPBA	1.7		2.5			
		CEA or CEB before CPAB or CPBA	2.0		2.8		ns	
t <sub>H</sub>	Hold Time	A or B after CPAB or CPBA	0.8		0.0			
		CEA or CEB after CPAB or CPBA			0.0		ns	
t <sub>OSLH</sub>	Output to Output Skew		1.0		1.0	ns		
t <sub>OSHL</sub>				1.0		1.0	115	

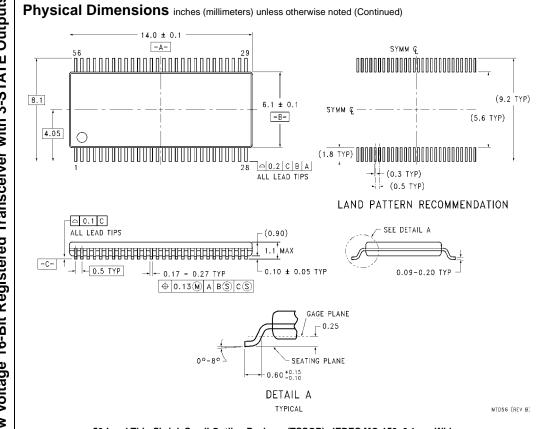
Note 10: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

### Capacitance (Note 11)

Symbol	Parameter	Conditions	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC} = OPEN$ , $V_I = 0V$ or $V_{CC}$	4	pF
C <sub>I/O</sub>	Input/Output Capacitance	$V_{CC} = 3.0 \text{V}, V_{C} = 0 \text{V or } V_{CC}$	8	pF

Note 11: Capacitance is measured at frequency f = 1 MHz, per MIL-STD-883, Method 3012.





56-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD56

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